

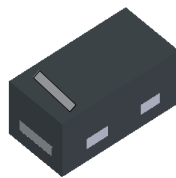
## Features

- Ultra-Small Leadless Surface Mount Package (0.6 x 0.3mm)
- Ultra-Low Profile Package (0.3mm)
- Ideally Suited for Automated Assembly Processes
- Low Leakage Current, Suitable for Battery-Powered Applications
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

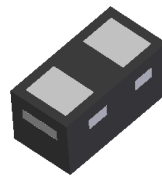
## Mechanical Data

- Case: X3-DFN0603-2
- Case Material: Molded Plastic, "Green" Molding Compound.  
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish – Matte Tin over Copper Leadframe.  
Solderable per MIL-STD-202, Method 208 (E3)
- Weight: 0.2 mg (Approximate)

X3-DFN0603-2



Top View



Bottom View



## Ordering Information (Note 4)

Part Number (Type Number)-7*	Case X3-DFN0603-2	Packaging 10,000/Tape & Reel
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\*Add "-7" to the appropriate type number in Electrical Characteristics Table. Example: 6.2V Zener = GDZ6V2LP3-7.

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information

Pin 1



xx = Product Type Marking Code  
(See Electrical Characteristics Table)  
Line Denotes Cathode Side

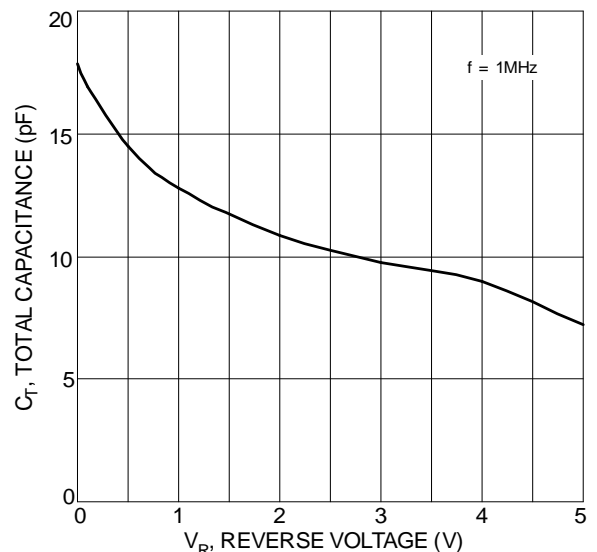
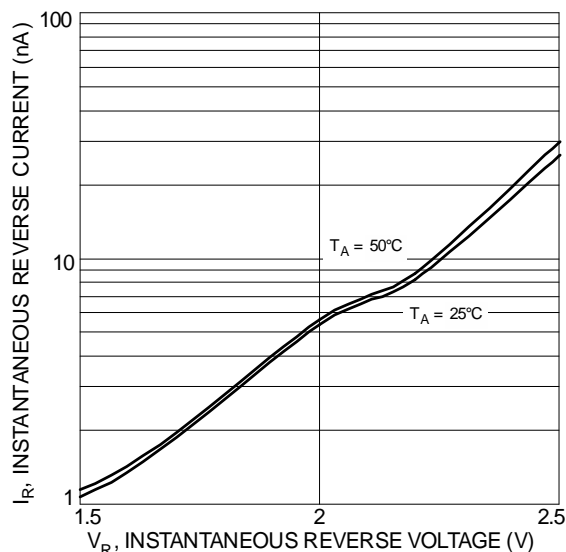
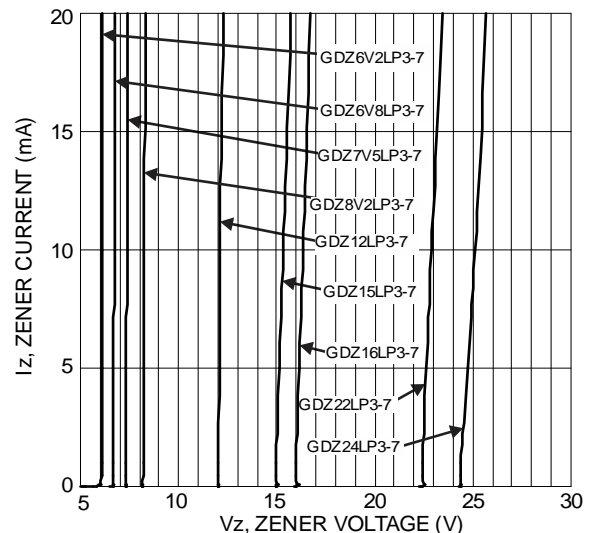
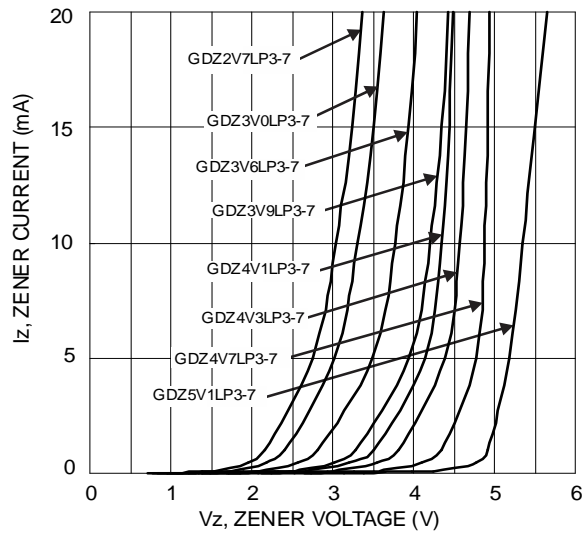
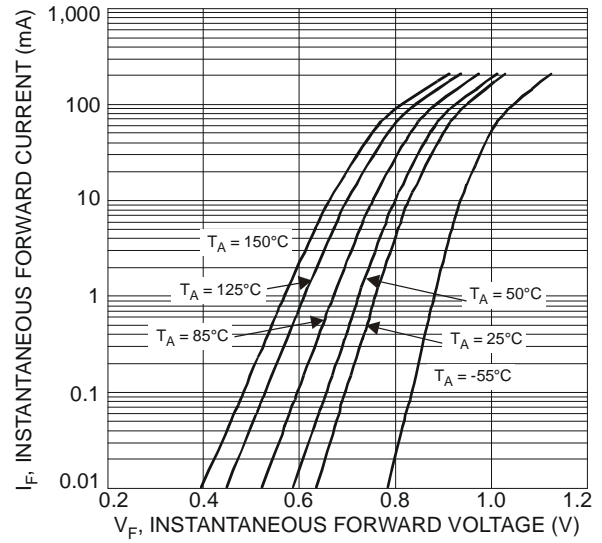
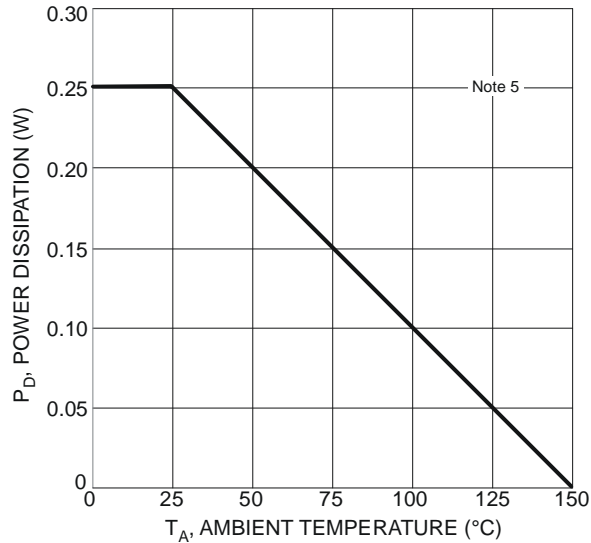
## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5) $T_A = +25^{\circ}\text{C}$	$P_D$	250	mW
Thermal Resistance, Junction to Ambient Air (Note 5) $T_A = +25^{\circ}\text{C}$	$R_{\theta JA}$	500	$^{\circ}\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	$^{\circ}\text{C}$

## Electrical Characteristics (@ $T_A = +25^{\circ}\text{C}$ , unless otherwise specified.)

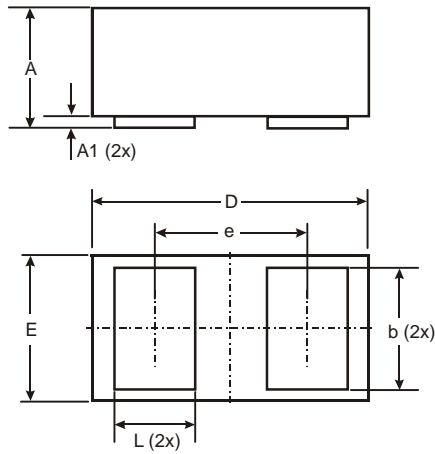
Type Number	Marking Code	Zener Voltage Range (Note 6)				Reverse Current (Note 6)		
		$V_Z @ I_{ZT}$			$I_{ZT}$	$I_R$		@ $V_R$
		Nom (V)	Min (V)	Max (V)	mA	Typical ( $\mu\text{A}$ )	Max ( $\mu\text{A}$ )	V
GDZ2V7LP3	JB	2.7	2.57	2.84	5	-	20	1.0
GDZ3V0LP3	JC	3.0	2.85	3.15	5	-	10	1.0
GDZ3V3LP3	JD	3.3	3.14	3.47	5	-	10	1.0
GDZ3V6LP3	KU	3.6	3.41	3.79	5	-	10	1.0
GDZ3V9LP3	KJ	3.9	3.740	4.160	5	-	5	1.0
GDZ4V1LP3	KY	4.1	3.93	4.37	5	-	5.0	1.0
GDZ4V3LP3	KK	4.3	4.08	4.53	5	-	5.0	1.0
GDZ4V7LP3	KL	4.7	4.420	4.900	5	-	2.0	1.0
GDZ5V1LP3	KM	5.1	4.840	5.370	5	-	0.2	2.0
GDZ5V6LP3	KN	5.6	5.310	5.920	5	- 90	1.0 175	2.5 4.75
GDZ6V0LP3	KW	6.0	5.676	6.324	5	-	1.0	2.8
GDZ6V2LP3	KO	6.2	5.860	6.530	5	-	1.0	3.0
GDZ6V8LP3	KT	6.8	6.470	7.140	5	-	0.5	3.5
GDZ7V5LP3	KQ	7.5	7.060	7.840	5	-	0.5	4.0
GDZ8V2LP3	KX	8.2	7.760	8.640	5	-	0.5	5.0
GDZ9V1LP3	JE	9.1	8.65	9.56	5	-	0.5	6.0
GDZ10LP3	JF	10	9.50	10.50	5	-	0.2	7.0
GDZ11LP3	JG	11	10.45	11.55	5	-	0.1	8.0
GDZ12LP3	JH	12	11.40	12.60	5	-	0.1	8.0
GDZ13LP3	JI	13	12.35	13.65	5	-	0.1	8.0
GDZ15LP3	JJ	15	14.25	15.75	5	-	0.1	10.5
GDZ16LP3	JK	16	15.20	16.80	5	-	0.1	11.2
GDZ18LP3	JL	18	17.10	18.90	5	-	0.1	12.6
GDZ20LP3	JM	20	19.00	21.00	5	-	0.1	14.0
GDZ22LP3	JN	22	20.90	23.10	5	-	0.1	15.4
GDZ24LP3	JO	24	22.80	25.20	5	-	0.1	16.8

- Notes:
- Device mounted on FR-4 PCB with minimum recommended pad layout, as shown in Diodes Incorporated's Suggested Pad Layout document, which can be found on our website at <http://www.diodes.com>.
  - Short duration pulse test used to minimize self-heating effect.



## Package Outline Dimensions

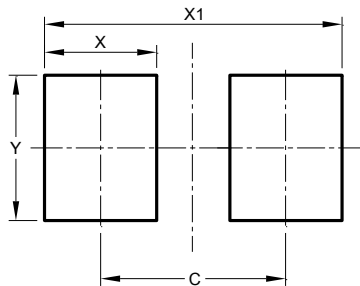
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



X3-DFN0603-2			
Dim	Min	Max	Typ
A	0.27	0.35	0.30
A1	0.00	0.03	0.02
b	0.19	0.29	0.24
D	0.595	0.645	0.62
E	0.295	0.345	0.32
e	-	-	0.355
L	0.14	0.24	0.19
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	0.380
X	0.230
X1	0.610
Y	0.300

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